

# **Sharpness for Display**

#### Description

The CXA2093S is a bipolar IC which performs contour accentuation for display RGB signals.

#### Features

- Sharpness time constant selection (50ns/100ns)
- Built-in sync separator for sync on green
- Differential output pins
- Built-in wide-band amplifier (200MHz/-3dB@0.7Vp-p)

#### Applications

Display

#### Structure

Bipolar silicon monolithic IC

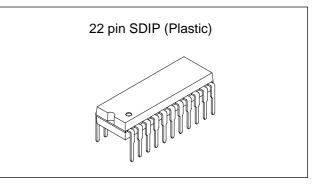
#### Absolute Maximum Ratings (Ta = 25°C, GND = 0V)

- Supply voltage
   Operating temperature
   Topr -20 to +75 °C
- Operating temperature Topr -20 to +75 °C
   Storage temperature Tstg -65 to +150 °C
- Allowable power dissipation  $P_D$  1.13 W

#### **Operating Conditions**

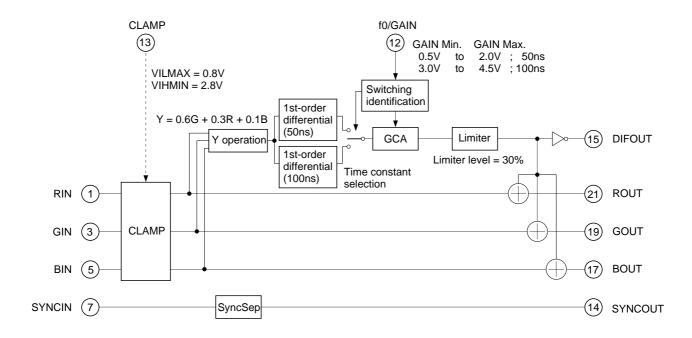
Supply voltage Vcc	5 ± 0.25 V
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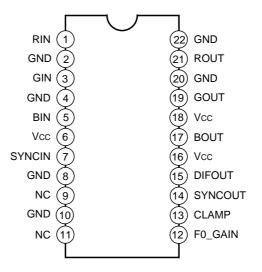


# CXA2093S

#### **Block Diagram**



#### **Pin Configuration**



# **Pin Description**

Pin No.	Symbol	Pin voltage	Equivalent circuit	Description		
1 3 5	RIN GIN BIN		Vcc	RGB input pins. Input these pins through capacitor.		
2, 4 8, 10 20, 22	GND			GND pins.		
7	SYNCIN		Vcc Vcc Vcc Vcc Vcc Vcc $7$	Sync input pin for sync on green. Input this pin through capacitor.		
12	F0_GAIN		Vcc Vcc Vcc ↓ ↓ ↓ ↓ ↓ ↓ ↓ ↓ ↓ ↓ ↓ ↓ ↓ ↓ ↓ ↓ ↓ ↓ ↓	Sharpness time constant selection and gain control pin.		
13	CLAMP		Vcc Vcc ↓ ↓ ↓ 50k 13 ↓ ↓ ↓ ↓ ↓ ↓ ↓ ↓ ↓ ↓ ↓ ↓ ↓ ↓ ↓ ↓ ↓ ↓ ↓	Clamp pulse input pin. ILMAX; 0.8V IHMIN; 2.8V		

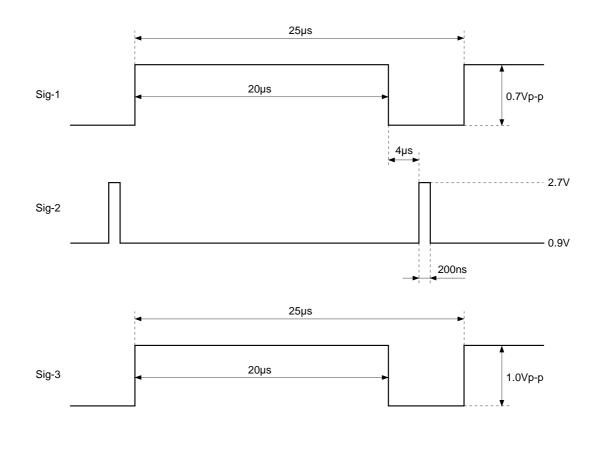
Pin No.	Symbol	Pin voltage	Equivalent circuit	Description	
14	SYNCOUT		Vcc Vcc Vcc Vcc (14) 150 177 177 177 177 177 177	Sync output pin. 0 to 4.3V positive polarity pulse is output in synchronizing with sync.	
15	DIFOUT		Vcc Vcc Vcc 1p 625 15 777 777 777 777 777	Differential signal output pin.	
6, 16 18, 20	Vcc	5V (applied)		Power supply pins.	
19 21 23	BOUT GOUT ROUT		$\begin{array}{c} Vcc  Vcc \\ 19 \\ 21 \\ 23 \\ 777  777 \\ 777 \\ 777 \\ 777 \\ 777 \\ 777 \end{array}$	RGB signal output pins.	

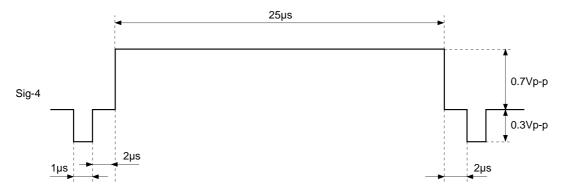
# **Electrical Characteristics**

(Ta = 25°C, Vcc = 5V)

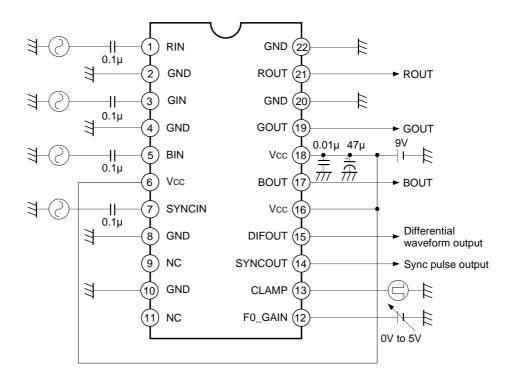
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No.	Item	Symbol	Measure- ment pins	Input signals	Measurement contents	Min.	Тур.	Max.	Unit
1	Power consumption	lcc	6 16 18		Vcc pin inflow current	45	69	95	mA
2	I/O gain R	VGR	21		Input video signal to Pins 1, 3 and 5, input clamp pulse to Pin 13, and	-0.5	0.5	1.5	dB
3	I/O gain G	VGG	19	Pins 1, 3, 5: Sig-1 Pin 13: Sig-2	measure the output amplitude of each output pin. Then calculate the I/O gain.	-0.5	0.5	1.5	dB
4	I/O gain B	VGB	17		$VGR = 20 \log \frac{\text{output amplitude}}{0.7}$	-0.5	0.5	1.5	dB
5	Input dynamic range	Drng	17 19 21	Pins 1, 3, 5: Sig-3 Pin 13: Sig-2	Input video signal to Pins 1, 3 and 5, input clamp pulse to Pin 13, and measure the output amplitude of each output pin.	0.9	1.05	1.2	Vp-p
6	Sharpness gain 1	VSG1	19	Pins 1, 3, 5: CW Pin 13: 5 V Pin 12: 0.5 V	Input 30MHz and 0.1Vp-p sine wave to Pins 1, 3 and 5, and measure the output amplitude of Pin 19.	60	110	150	mVp-p
7	Sharpness gain 2	VSG2	19	Pins 1, 3, 5: CW Pin 13: 5 V Pin 12: 2.5 V	Input 30MHz and 0.1Vp-p sine wave to Pins 1, 3 and 5, and measure the output amplitude of Pin 19. Then calculate the I/O gain. VGR = 20 log $\frac{\text{output amplitude}}{0.1}$	5.0	7.0	9.0	dB
8	Sharpness gain 3	VSG3	19	Pins 1, 3, 5: CW Pin 13: 5 V Pin 12: 3.0 V	Input 30MHz and 0.1Vp-p sine wave to Pins 1, 3 and 5, and measure the output amplitude of Pin 19.	60	110	150	mVp-p
9	Sharpness gain 4	VSG4	19	Pins 1, 3, 5: CW Pin 13: 5 V Pin 12: 4.5 V	Input 30MHz and 0.1Vp-p sine wave to Pins 1, 3 and 5, and measure the output amplitude of Pin 19. Then calculate the I/O gain. $VGR = 20 \log \frac{output amplitude}{0.1}$	5.0	7.0	9.0	dB
10	DIFOUT output level	VDF	15	Pin 1: CW Pin 13: 5 V Pin 12: 4.5 V	Input 30MHz and 0.3Vp-p sine wave to Pin 1, and measure the output amplitude of Pin 15.	290	375	455	mVp-p
11	SYNCSEP output high level	VSHi			Input video signal to Pin 7, and measure the high level of Pin 14.	3.9	4.2	4.5	V
12	SYNCSEP output low level	VSLo	14	Pin 7: Sig-4	Input video signal to Pin 7, and measure the low level of Pin 14.	0.1	0.18	0.26	V
13	SYNCSEP output delay 1	SDtr				0	19	40	ns
14	SYNCSEP output delay 1	SDtf			→	30	51	70	ns

### **Signals Used for Measurement**

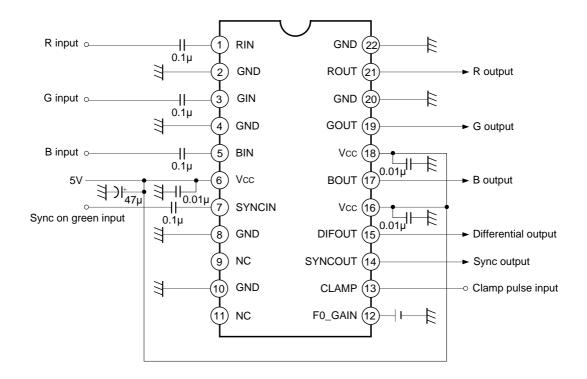




#### **Electrical Characteristics Measurement Circuit**



#### **Application Circuit**

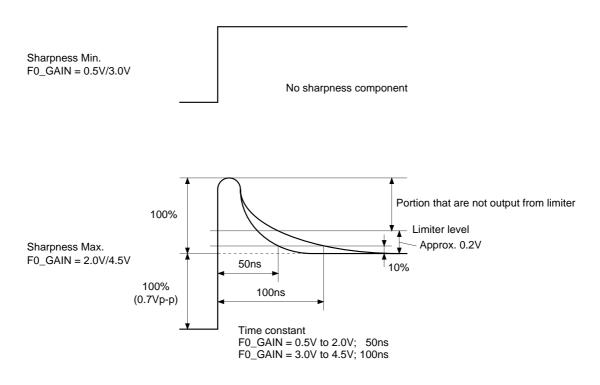


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#### **Description of Operation**

#### 1. Video signal system

RGB signals input to Pins 1, 3 and 5 is synchronous clamped by the clamp pulse input from Pin 13. This RGB signals are mixed in the ratio of 0.6G + 0.3R + 0.1B, and Y signal is generated. The high frequency component is pulled out from a Y signal through a differential circuit, and the amplitude is varied according to the gain control circuit. The selecting of gain control and differential circuit time constant is performed by the DC voltage input from Pin 12. Gain controlled signal is output from Pin 15 after amplitude limited from a limiter circuit. At the same time, its signal is added to RGB signals input to Pins 1, 3 and 5, and then is output from Pins 17, 19 and 21.

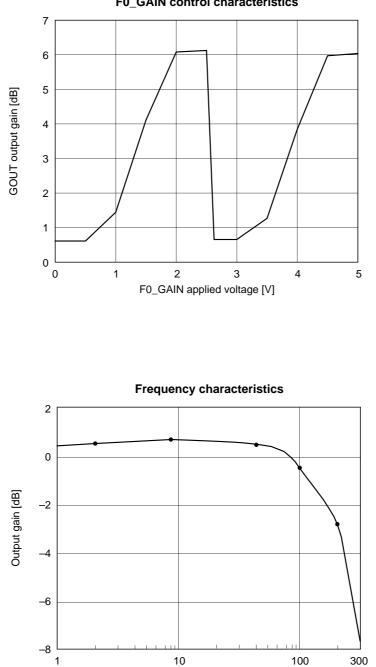


#### 2. Synchronous system

The sync on green signal input to Pin 7 is synchronous separated by the sync separation circuit after diode clamped, and is output from Pin 14 as a positive polarity pulse.

The input signal is not sync on green signal, video portion is sliced and then is output as a positive polarity pulse.

# **Example of Representative Characteristics**



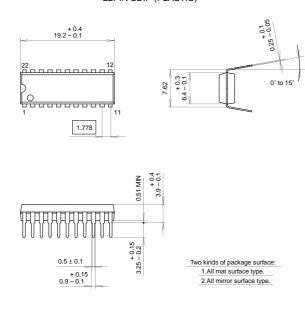
**F0\_GAIN** control characteristics

Input frequency [MHz]

#### Package Outline

Unit: mm

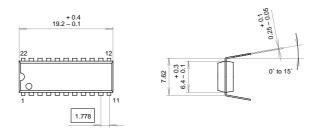
22PIN SDIP (PLASTIC)

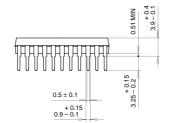


#### PACKAGE STRUCTURE

		MOLDING COMPOUND	EPOXY RESIN
SONY CODE	SDIP-22P-01	LEAD TREATMENT	SOLDER PLATING
EIAJ CODE	SDIP022-P-0300	LEAD MATERIAL	COPPER ALLOY
JEDEC CODE		PACKAGE MASS	0.95g

#### 22PIN SDIP (PLASTIC)





 Two kinds of package surface:

 1.All mat surface type.

 2.All mirror surface type.

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EIAJ CODE	SDIP022-P-0300	LEAD MATERIAL	COPPER ALLOY
JEDEC CODE		PACKAGE MASS	0.95g

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#### LEAD PLATING SPECIFICATIONS

ITEM	SPEC.
LEAD MATERIAL	COPPER ALLOY
SOLDER COMPOSITION	Sn-Bi Bi:1-4wt%
PLATING THICKNESS	5-18µm